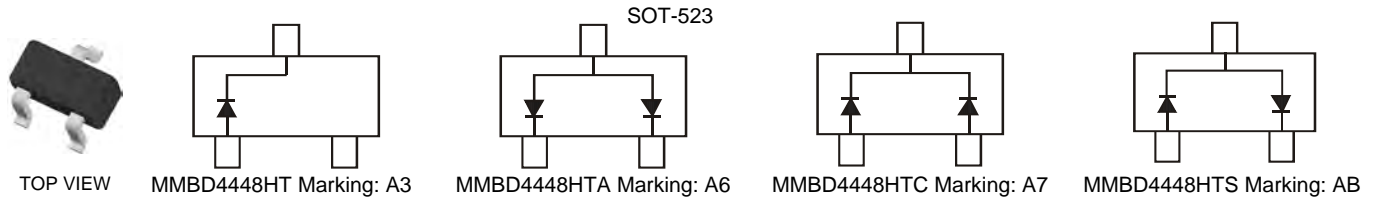


Features

- Ultra-Small Surface Mount Package
- Fast Switching Speed
- For General Purpose Switching Applications
- High Conductance
- **Lead Free/RoHS Compliant (Note 2)**
- **"Green" Device (Notes 3 and 4)**

Mechanical Data

- Case: SOT-523
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: See Diagrams Below
- Marking Information: See Diagrams Below & Page 2
- Ordering Information: See Page 2
- Weight: 0.002 grams (approximate)



Maximum Ratings @_{T_A} = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	V_{RM}	100	V
Peak Repetitive Reverse Voltage	V_{RRM}	80	V
Working Peak Reverse Voltage	V_{RWM}		
DC Blocking Voltage	V_R		
RMS Reverse Voltage	$V_{R(RMS)}$	57	V
Forward Continuous Current (Note 1)	I_{FM}	500	mA
Average Rectified Output Current (Note 1)	I_O	250	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0µs	I_{FSM}	4.0	A
@ t = 1.0s		2.0	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	P_D	150	mW
Thermal Resistance Junction to Ambient (Note 1)	$R_{\theta JA}$	833	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +150	°C

Electrical Characteristics @_{T_A} = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	$V_{(BR)R}$	80	—	V	$I_R = 2.5\mu A$
Forward Voltage	V_F	0.62	0.72	V	$I_F = 5.0mA$
		—	0.855		$I_F = 10mA$
		—	1.0		$I_F = 100mA$
		—	1.25		$I_F = 150mA$
Leakage Current (Note 5)	I_R	—	100	nA	$V_R = 70V$
		—	50	µA	$V_R = 75V, T_J = 150^\circ C$
		—	30	µA	$V_R = 25V, T_J = 150^\circ C$
		—	25	nA	$V_R = 20V$
Total Capacitance	C_T	—	3.5	pF	$V_R = 6V, f = 1.0MHz$
Reverse Recovery Time	t_{rr}	—	4.0	ns	$V_R = 6V, I_F = 5mA$

- Notes:
1. Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
 2. No purposefully added lead.
 3. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
 4. Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.
 5. Short duration pulse test used to minimize self-heating effect.

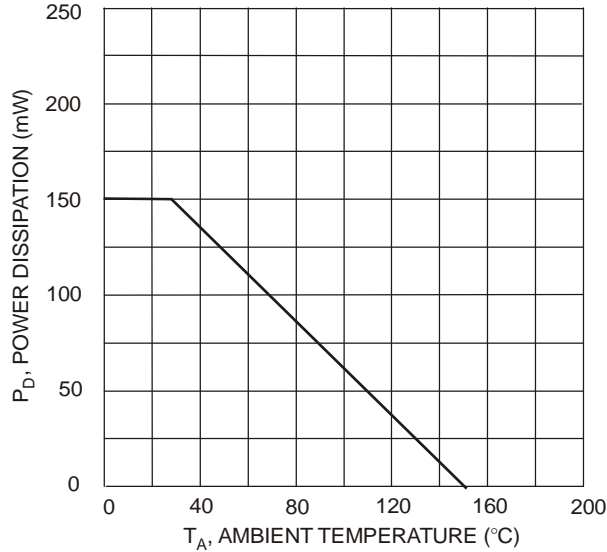


Fig. 1 Power Derating Curve, Total Package

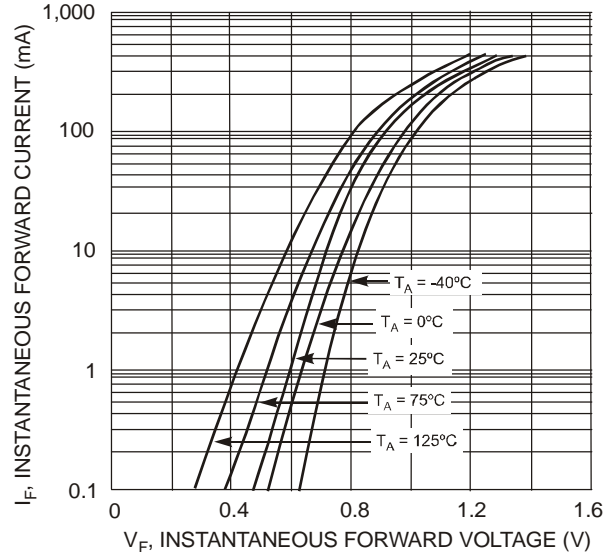


Fig. 2 Typical Forward Characteristics, Per Element

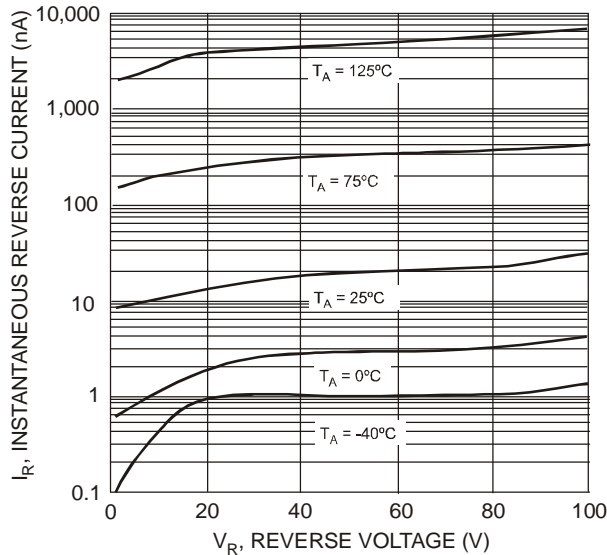


Fig. 3 Typical Reverse Characteristics, Per Element

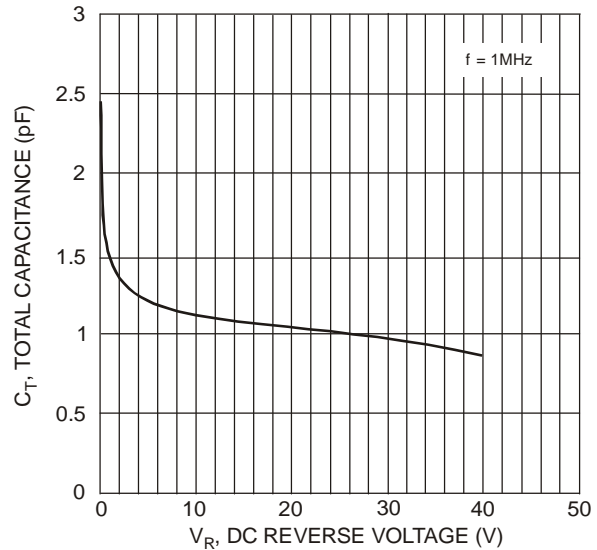


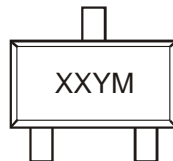
Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

Ordering Information (Note 6)

Part Number	Case	Packaging
MMBD4448HT-7-F	SOT-523	3000/Tape & Reel
MMBD4448HTA-7-F	SOT-523	3000/Tape & Reel
MMBD4448HTC-7-F	SOT-523	3000/Tape & Reel
MMBD4448HTS-7-F	SOT-523	3000/Tape & Reel

Notes: 6. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information

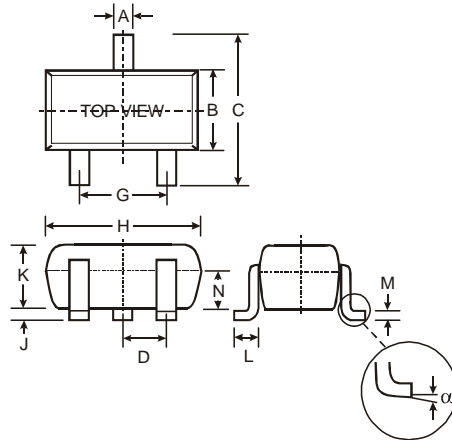


xx = Product Type Marking Code (See Page 1 Diagrams)
 YM = Date Code Marking
 Y = Year (ex: N = 2002)
 M = Month (ex: 9 = September)

Date Code Key

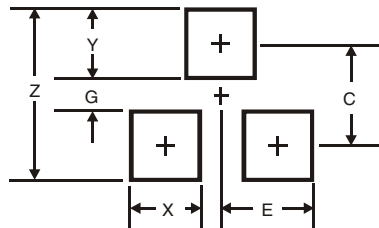
Year	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	M	N	P	R	S	T	U	V	W	X	Y	Z
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Package Outline Dimensions



SOT-523			
Dim	Min	Max	Typ
A	0.15	0.30	0.22
B	0.75	0.85	0.80
C	1.45	1.75	1.60
D	—	—	0.50
G	0.90	1.10	1.00
H	1.50	1.70	1.60
J	0.00	0.10	0.05
K	0.60	0.80	0.75
L	0.10	0.30	0.22
M	0.10	0.20	0.12
N	0.45	0.65	0.50
α	0°	8°	—
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.9
G	0.9
X	0.5
Y	0.5
C	1.4
E	0.5

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